



## INTERNATIONAL COMPETITIVE BIDDING (ICB)

### SUPPLY OF MACHINES AND EQUIPMENT

PROJECT NAME: TECHNOLOGY CENTRE SYSTEMS PROGRAMME (TCSP) - A WORLD BANK PROJECT

#### 1. BACKGROUND

The Government of India has received a loan of USD 200 Million from the International Bank for Reconstruction and Development towards the cost of Technology Centre Systems Programme (TCSP), and it is intended that part of the proceeds will be utilized for payments under the Contract(s) to be placed for Procurement of machines and equipments against these ICBs.

#### 2. INVITATION OF BIDS

The Development Commissioner (MSME), Ministry of MSME, Government of India now invites sealed bids from eligible and qualified bidders for the Procurement of Machines and Equipment REF: **ICB No. 21/ TCSP/ GOODS/ P7/ 2016/ TR/ TC (Package - 7)** and **ICB No. 21/ TCSP/ GOODS/ P8/ 2016/ TR/ TC (Package - 8)**. The lists of equipment are given in the Schedule of Requirements contained in the bidding documents.

#### 3. INFORMATION

Interested eligible bidders may obtain further information and inspect the bidding documents at the office of the Director (Tool Room), Office of Development Commissioner, Micro, Small & Medium Enterprises (MSME), Room No. 723 (A) Government of India, 'A' Wing, 7th Floor, Nirman Bhawan, Maulana Azad Road, New Delhi - 110 108 during office hours from 22<sup>nd</sup> April, 2016 to 6<sup>th</sup> May, 2016.

A complete set of bidding documents in English language can be downloaded free of cost by the bidders from the website [www.dcmsme.gov.in/tcsp.html](http://www.dcmsme.gov.in/tcsp.html)

The interested bidders or authorized representatives (bearing Authorization Letter) are invited to attend a pre bid meeting on the date and time specified in the table below at the address mentioned in the bidding document.

The bidders shall be solely responsible for checking the website for any Addendum/Corrigendum issued in regards to the ICB and take into consideration the same while preparing and submitting the bids.

**Important Dates and time are mentioned below:**

Activity	Package - 7 ICB No. 21/TCSP/GOODS/P7/2016/TR/TC	Package - 8 ICB No. 21/TCSP/GOODS/P8/2016/TR/TC
Pre Bid meeting	9 <sup>th</sup> May, 2016 at 1500 Hrs. (IST)	9 <sup>th</sup> May, 2016 at 1600 Hrs. (IST)
Bid Submission closing time and date	6 <sup>th</sup> June, 2016 at 1500 Hrs. (IST)	15 <sup>th</sup> June, 2016 at 1500 Hrs. (IST)
Bid opening time and date	6 <sup>th</sup> June, 2016 at 1530 Hrs. (IST)	15 <sup>th</sup> June, 2016 at 1530 Hrs. (IST)

#### 4. SUBMISSION OF BIDS

**Closing time and date** of submitting bids at the below mentioned address is specified in the table above. All bids must be accompanied by a Bid Security as specified in Bidding documents. Bids will be publically opened in the presence of the bidders' designated representatives (bearing Authorization Letter), who choose to attend in person at the address mentioned in the bidding documents at **time and date mentioned in table above.**

Director (Tool Room), O/o DC, MSME,  
Room No 723 (A), A Wing, 7th Floor, Nirman Bhawan,  
Maulana Azad Road, New Delhi - 110108  
Tel: +91 11 23062561; Fax: +91 11 23061068  
E mail: [tcsp@dcmsme.gov.in](mailto:tcsp@dcmsme.gov.in)

Please also visit: [www.msme.gov.in](http://www.msme.gov.in)

[www.dcmsme.gov.in](http://www.dcmsme.gov.in)

[www.udyogaadhaar.gov.in](http://www.udyogaadhaar.gov.in)

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